

(V) Preliminary Specifications () Final Specifications

Module	" WXGA Color TFT-LCD with LED Backlight design	
Model Name	B121EW09 V0	
Note (🗭)	LED Backlight with driving circuit design	

Customer	Date	Approved by Date
Checked & Approved by	Date	Prepared by
Note: This Specification is subject without notice.	ct to change	NBBU Marketing Division / AU Optronics corporation

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Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.1 2008/01/10	AII	First Edition for Customer		
0.2 2008/01/22	19	6.3 Signal Description/Pin Assignment à 0.1 version	6.3 Signal Description/Pin Assignment à 0.2 version	
0.3 2008/02/18	<mark>21</mark>	Clock frequency:	Clock frequency:	
		1. 68.9 MHz	1. 69.4 MHz	
		2. Horizontal Section, Blanking: 128	2. Horizontal Section, Blanking: 136	

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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.

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2. General Description

B121EW09 V0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the WXGA (1280(H) x 800(V)) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B121EW09 V0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit	Specifications				
Screen Diagonal	[mm]	307.9 (W")				
Active Area	[mm]	261.12(H) X	163.2(V)			
Pixels H x V		1280x3(RGB) x 800			
Pixel Pitch	[mm]	0.204X0.204				
Pixel Arrangement		R.G.B. Vertic	al Stripe			
Display Mode		Normally Wh	ite			
White Luminance (ILED=20mA) Note: ILED is LED current	[cd/m ²]	200 typ. (5 points average) 170 min. (5 points average) (Note1)				
Luminance Uniformity		1.25 max. (5	points)			
Contrast Ratio		400 typ				
Response Time	[ms]	16 typ / 25 M	ax			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	4.5 max. (Inc	lude Logic an	d Black Lig	ht power)	
Weight	[Grams]	270 max.				
Physical Size	[mm]		L	W	Т	
		Max	276.3	178.6	5.2	
		Typical 275.8 178 -			-	
		Min 275.3 - -				
Electrical Interface		1 channel LVDS				
Surface Treatment		Glare, Hardn	ess 3H,			

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Support Color		262K colors (RGB 6-bit)
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +65
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

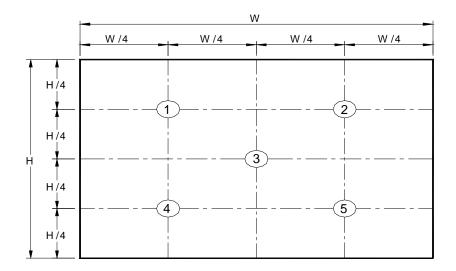
Item	Unit	Conditions	Min.	Тур.	Max.	Note
White Luminance ILED=20mA	[cd/m ²]	5 points average	170	200	-	1, 4, 5.
Viewing Angle	[degree] [degree]	Horizontal (Right) CR = 10 (Left)	40 40	45 45	-	8
	[degree] [degree]	Vertical (Upper) CR = 10 (Lower)	10 30	15 35	-	
Luminance Uniformity		5 Points	-	-	1.25	1
Luminance Uniformity		13 Points	-	-	1.50	2
CR: Contrast Ratio		DCR:Off	300	400	-	6
Cross talk	%				4	7
Response Time	[msec]	Rising	-	TBD	-	8
	[msec]	Falling	-	TBD	-	
	[msec]	Rising + Falling	-	16	25	
		Red x		TBD		2,8
		Red y		TBD		
Chromaticity of color		Green x		TBD		
Coordinates		Green y		TBD		
(CIE 1931)		Blue x		TBD		
		Blue y		TBD		
		White x	0.263	0.313	0.363	
		White y	0.279	0.329	0.379	

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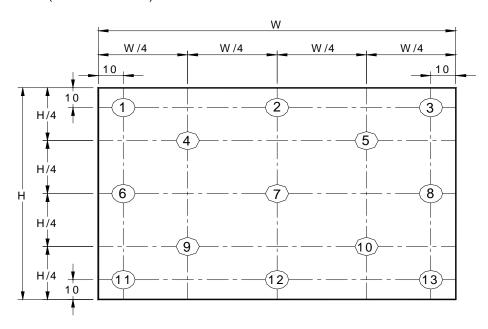


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Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or13 points is defined by dividing the maximum luminance values by the minimum test point luminance

2		Maximum Brightness of five points
δ w5	=	Minimum Brightness of five points
2		Maximum Brightness of thirteen points
δ w13	=	Minimum Brightness of thirteen points

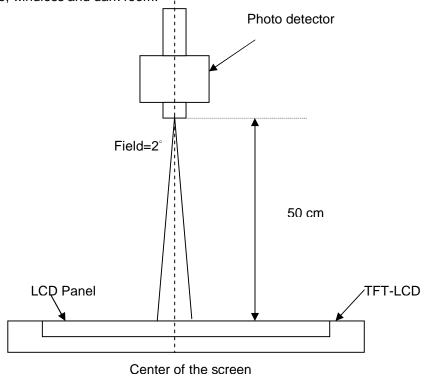
Note 4: Measurement method

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The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points , $Y_L = [L (1) + L (2) + L (3) + L (4) + L (5)] / 5 L (x) is corresponding to the luminance of the point X at Figure in Note (1).$

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

$$CT = | Y_B - Y_A | / Y_A \times 100 (\%)$$

Where

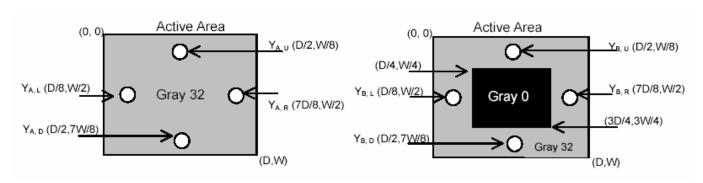
YA = Luminance of measured location without gray level 0 pattern (cd/m2)

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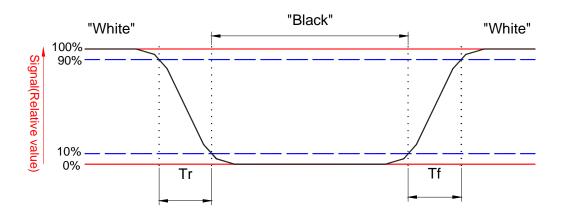
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Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)



Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from釘lack" to \times\times (falling time) and from \times\times \times\times (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



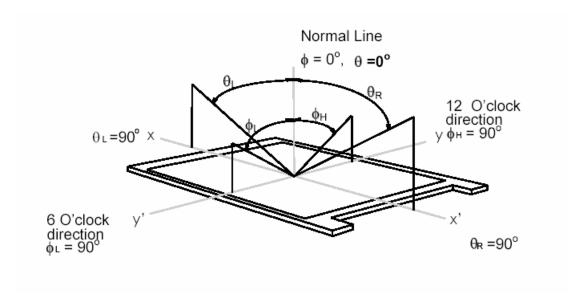
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Note 8. Definition of viewing angle

Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (F) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.

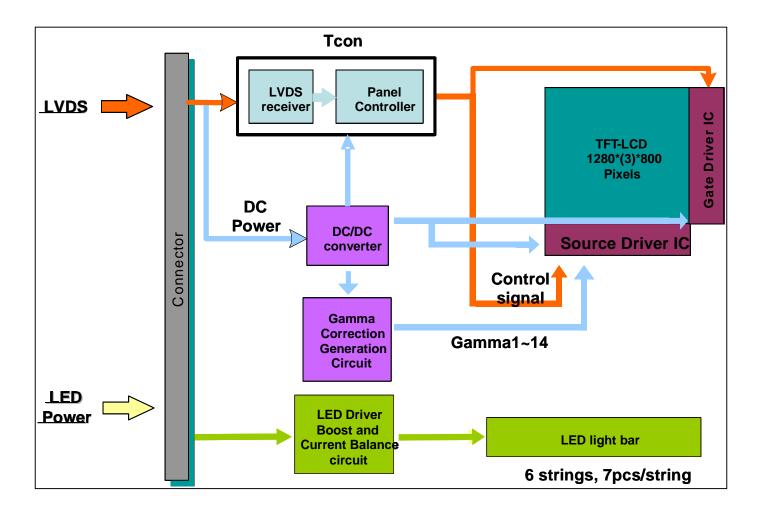


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3. Functional Block Diagram

The following diagram shows the functional block of the 12.1 inches wide Color TFT/LCD 40 Pin (One ch/connector Module:



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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Backlight Unit

Item	Symbol	Min	Max	Unit	Conditions
LED Driving Voltage	V_{LED}	-	36 (Row Output)	[Volt]	Note 1,2,3
LED Driving Current	I _{LED}	-	30 (Row Output)	[mA] rms	Note 1,2,3

4.3 Absolute Ratings of Environment

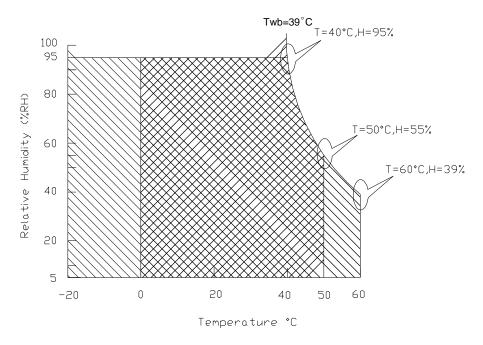
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	8	95	[%RH]	Note 4
Storage Temperature	TST	-20	+65	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

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5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

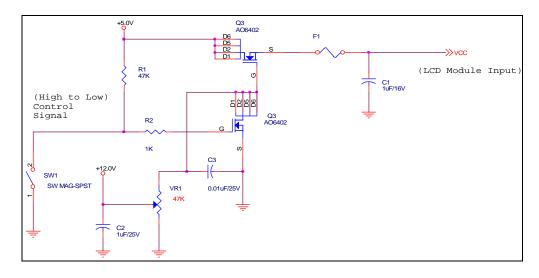
Input power specifications are as follows;

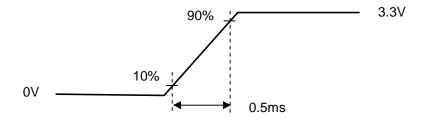
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	ı	-	TBD	[Watt]	Note 1/2
IDD	IDD Current	1	TBD	TBD	[mA]	Note 1/2
lRush	Inrush Current	ı	-	2000	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	1	-	TBD	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern

Note 2: Typical Measurement Condition: Mosaic Pattern

Note 3: Measure Condition





Vin rising time

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5.1.2 Signal Electrical Characteristics

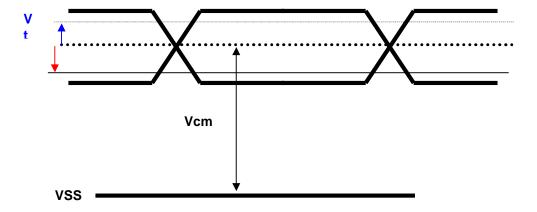
Input signals shall be low or High-impedance state when VDD is off.

It is recommended to refer the specifications of THC63LVDF84A (Thine Electronics Inc.) in detail.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
Vth	Differential Input High Threshold (Vcm=+1.2V)	-	100	[mV]
Vtl	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
Vcm	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform



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LED Parameter guideline for LED driving selection (Ref. Remark 1)

Parameter	Symbol	Min	Тур	Max	Units	Condition
LED Forward Voltage	V _F	2.95	3.15	3.35	[Volt]	(Ta=25°ℂ)
LED Forward Current	I _F		20	30	[mA]	(Ta=25°ℂ)
LED Power consumption	P _{LED}		3.78		[Watt]	(Ta=25°ℂ) Note 1
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25 $^{\circ}$ C) I _F =20 mA Note 2

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

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6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	0	1		1278	<mark>1279</mark>
1st Line	R G B	R G B		R G B	R G B
		,	-		
		,	•		
		٠	<u>:</u>		
		,	÷	•	:
			<u>:</u>		
			÷		:
	1	١	1	ı	1
		,		,	'
800th Line	R G B	R G B		R G B	R G B

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6.2 The input data format

RxCLKIN	
RxIN0	G0 R5 R4 R3 R2 R1 R0
RxIN1	B1 B0 G5 G4 G3 G2 G1
RxIN2	DE VS HS B5 B4 B3 B2

Cianal Nama	Description	
Signal Name	Description (MOD)	D. L. J. J. D. G.
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	D. I. d. al D. d.	
	Red-pixel Data	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The typical frequency is 68.9 MHZ The signal
		is used to strobe the pixel data and DE signals.
		All pixel data shall be valid at the falling edge
		when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
		data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.

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6.3 Signal Description/Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

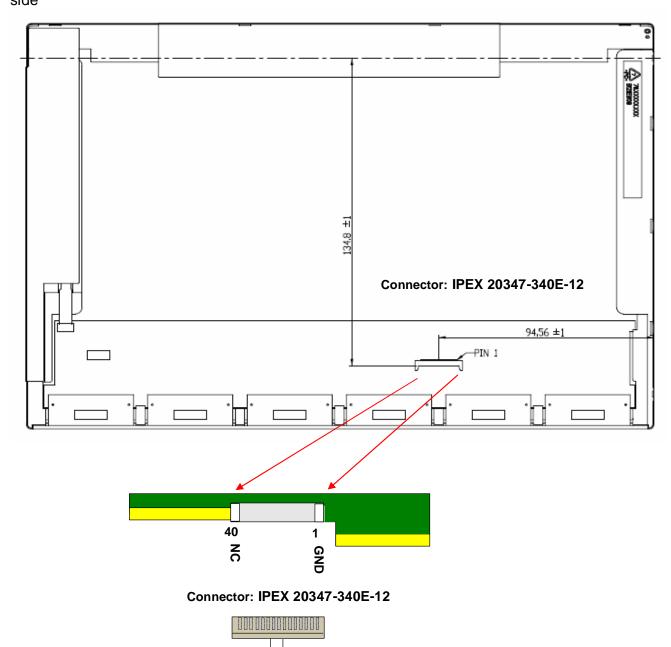
PIN#	Symbol	Function
1	GND	Ground
2	VDD	+3.3V Power Supply
3	VDD	+3.3V Power Supply
4	V _{EDID}	+3.3V EDID Power
5	NC	No Connection (Reserve for AUO test)
6	CLKEDID	EDID Clock Input
7	DATA _{EDID}	EDID Data Input
8	RxIN0-	-LVDS differential data input (R0-R5, G0)
9	RxIN0+	+LVDS differential data input (R0-R5, G0)
10	GND	Ground
11	RxIN1-	-LVDS differential data input(G1-G5, B0-B1)
12	RxIN1+	+LVDS differential data input(G1-G5, B0-B1)
13	GND	Ground
14	RxIN2-	-LVDS differential data input(B2-B5, HS, VS, DE)
15	RxIN2+	+LVDS differential data input(B2-B5, HS, VS, DE)
16	GND	Ground
17	RxCLKIN-	-LVDS differential clock input
18	RxCLKIN+	+LVDS differential clock input
19	GND	Ground
20	NC	No Connection (Reserve for AUO test)
21	NC	No Connection (Reserve for AUO test)
22	GND	Ground
23	NC	No Connection (Reserve for AUO test)
24	NC	No Connection (Reserve for AUO test)
25	GND	Ground
26	NC	No Connection (Reserve for AUO test)
27	NC	No Connection (Reserve for AUO test)
28	NC	No Connection (Reserve for AUO test)
29	NC	No Connection (Reserve for AUO test)
30	NC	No Connection (Reserve for AUO test)
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	VLED	LED Power Supply 7V-20V
35	VLED	LED Power Supply 7V-20V
36	VLED	LED Power Supply 7V-20V
37	VLED	LED Power Supply 7V-20V
38	S_PWMIN	System PWM signal Input
39	LED_EN	LED enable pin (+3V input)
40	NC	No Connect (Reserve for AUO test)

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side



Note2: Input signals shall be low or High-impedance state when VDD is off.

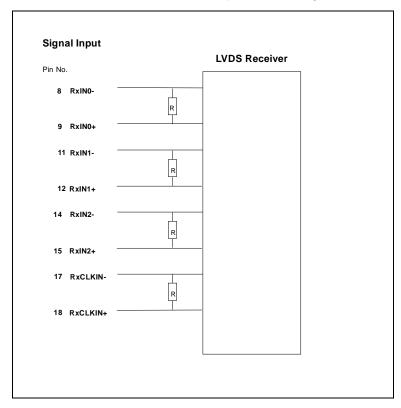
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internal circuit of LVDS inputs are as following.

The module uses a 100ohm resistor between positive and negative data lines of each receiver input



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6.4 Interface Timing

6.4.1 Timing Characteristics

Basically, interface timings should match the 1280x800 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame Rate		-	-	60	-	Hz
Clock fro	equency	1/ T _{Clock}	50-	69.3	80-	MHz
Vertical Section	Period	T _V	803	816	1023	
	Active	T _{VD}	800	800	800	T_Line
	Blanking	T _{VB}	3	16	223	
	Period	T _H	1303	1408	2047	
Horizontal	Active	T _{HD}	1280	1280	1280	T _{Clock}
Section	Blanking	T _{HB}	23	136	767	

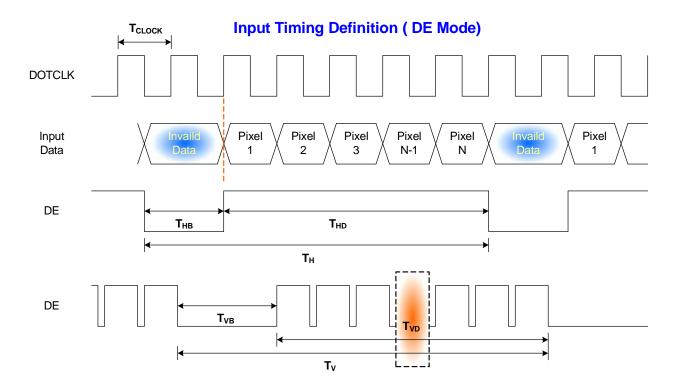
Note: DE mode only

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6.4.2 Timing diagram

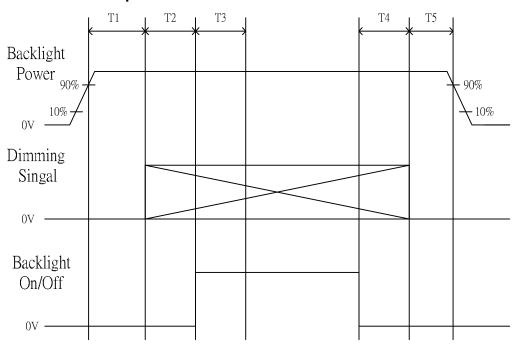


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6.5 LED Power Sequence



	Values			
Symbol	Min	Тур	Max	Unit
T1	10			ms
T2	10			ms
Т3	50			ms
T4	0			ms
T5	10			ms

Note: The duty of LED dimming signal should be more than 20% in T2 and T3.

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7. Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

7.1 TFT LCD Module

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	IPEX 20347-340E-12 or compatible
Mating Housing/Part Number	IPEX 20347-340E-12 or compatible

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8. 8. LED Driving Specification

8.1 Connector Description

It is a intergrative interface and comibe into LVDS connector. The type and mating refer to section 7.

8.2 Pin Assignment

PIN#	Signal Name	Description
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	VLED	LED Power Supply 7V-20V
35	VLED	LED Power Supply 7V-20V
36	VLED	LED Power Supply 7V-20V
37	VLED	LED Power Supply 7V-20V
38	S_PWMIN	System PWM signal Input
39	LED _EN	LED enable pin (+3V input)
40	NC	No Connect (Reserve for AUO)

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9. Reliability

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40 [°] C , 90%RH, 300h	
High Temperature Operation	Ta= 50 [°] C , Dry, 300h	
Low Temperature Operation	Ta= 0 [°] C , 300h	
High Temperature Storage	Ta= 60 [°] C , 300h	
Low Temperature Storage	Ta= -20 [°] C , 300h	
Thermal Shock Test	Ta=-20°ℂ to 60°ℂ , Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

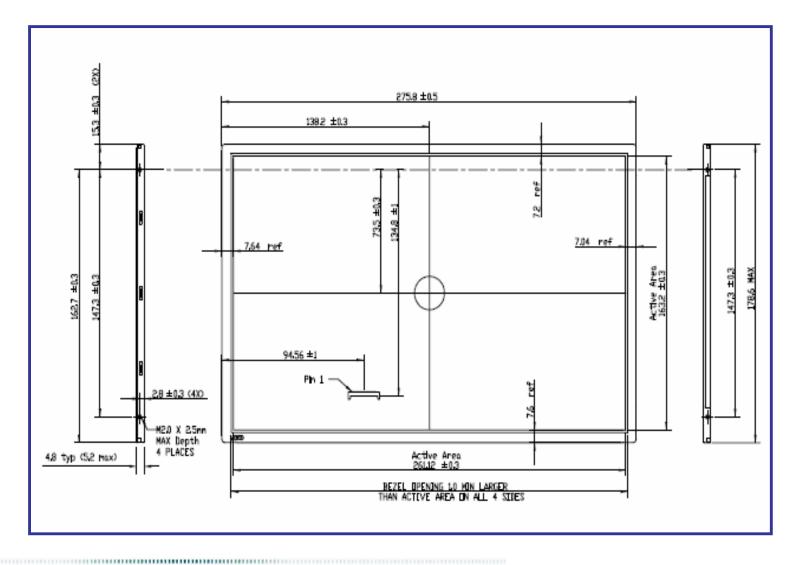
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10. Mechanical Characteristics

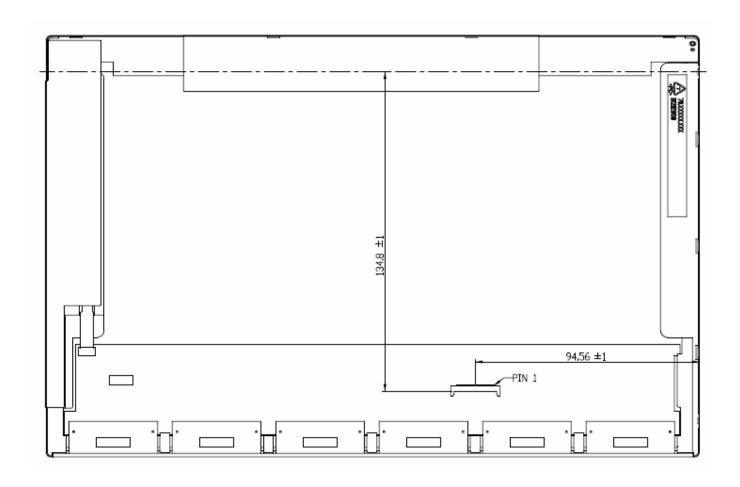
10.1 LCM Outline Dimension



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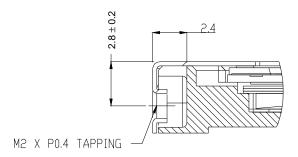


10.2 Screw Hole Depth and Center Position

Screw hole minimum depth, from side surface = 2.1 mm (See drawing)

Screw hole center location, from front surface = 2.8 ± 0.2 mm (See drawing)

Screw Torque: Maximum 2.5 kgf-cm



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11. Shipping and Package

11.1 Shipping Label Format

Manufactured 08/05 Model No: B121EW09 V0 AU Optronics MADE IN CHINA (S1)

0AXXG E204356

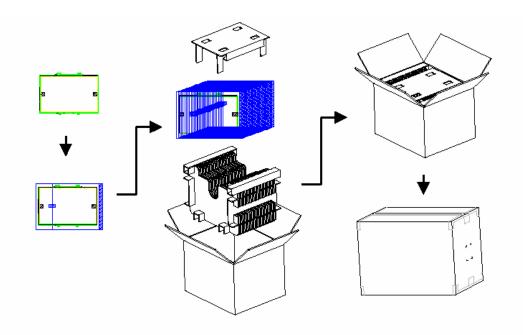
RoHS

HW: 0A FW:1

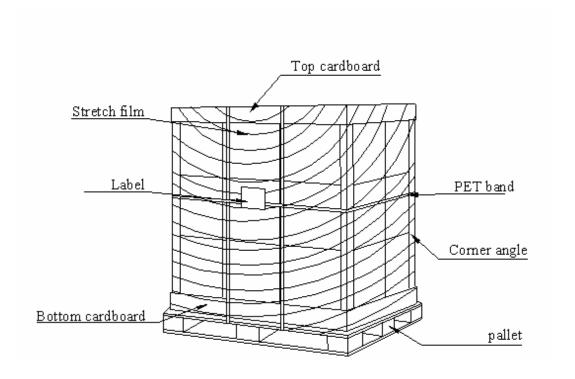
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11.2 Carton package



11.3 Shipping package of palletizing sequence



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12. Appendix: EDID description

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